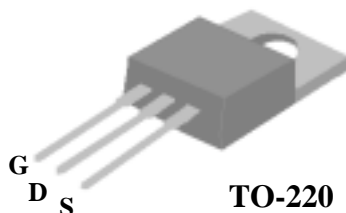




*N-CHANNEL ENHANCEMENT MODE  
POWER MOSFET*

- ▼ Low Gate Charge
- ▼ Simple Drive Requirement
- ▼ Fast Switching

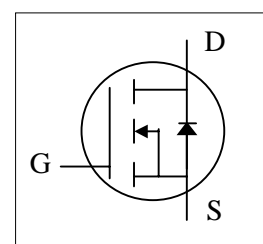


$BV_{DSS}$	30V
$R_{DS(ON)}$	80m $\Omega$
$I_D$	15A

## Description

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications and suited for low voltage applications such as DC/DC converters and high efficiency switching circuit.



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D @ T_C = 25^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10\text{V}$	15	A
$I_D @ T_C = 100^\circ\text{C}$	Continuous Drain Current, $V_{GS} @ 10\text{V}$	9	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	50	A
$P_D @ T_C = 25^\circ\text{C}$	Total Power Dissipation	28	W
	Linear Derating Factor	0.22	W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

## Thermal Data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal Resistance Junction-case	Max. 4.5	$^\circ\text{C}/\text{W}$
$R_{thj-amb}$	Thermal Resistance Junction-ambient	Max. 62	$^\circ\text{C}/\text{W}$



## AP15N03P

### Electrical Characteristics @T<sub>j</sub>=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	30	-	-	V
ΔBV <sub>DSS</sub> /ΔT <sub>j</sub>	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I <sub>D</sub> =1mA	-	0.037	-	V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =8A	-	-	80	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A	-	-	100	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1	-	3	V
I <sub>DSS</sub>	Drain-Source Leakage Current (T <sub>j</sub> =25°C)	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V	-	-	1	uA
	Drain-Source Leakage Current (T <sub>j</sub> =150°C)	V <sub>DS</sub> =24V, V <sub>GS</sub> =0V	-	-	25	uA
I <sub>GSS</sub>	Gate-Source Leakage	V <sub>GS</sub> = ± 20V	-	-	±100	nA
Q <sub>g</sub>	Total Gate Charge <sup>2</sup>	I <sub>D</sub> =8A	-	5.4	-	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =24V	-	1.3	-	nC
Q <sub>gd</sub>	Gate-Drain ("Miller") Charge	V <sub>GS</sub> =5V	-	3.6	-	nC
t <sub>d(on)</sub>	Turn-on Delay Time <sup>2</sup>	V <sub>DS</sub> =15V	-	3.6	-	ns
t <sub>r</sub>	Rise Time	I <sub>D</sub> =8A	-	19.8	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time	R <sub>G</sub> =3.3Ω, V <sub>GS</sub> =10V	-	13	-	ns
t <sub>f</sub>	Fall Time	R <sub>D</sub> =1.9Ω	-	3.2	-	ns
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V	-	260	-	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =25V	-	144	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f=1.0MHz	-	13	-	pF

### Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I <sub>S</sub>	Continuous Source Current ( Body Diode )	V <sub>D</sub> =V <sub>G</sub> =0V , V <sub>S</sub> =1.3V	-	-	15	A
I <sub>SM</sub>	Pulsed Source Current ( Body Diode ) <sup>1</sup>		-	-	50	A
V <sub>SD</sub>	Forward On Voltage <sup>2</sup>	T <sub>j</sub> =25°C, I <sub>S</sub> =15A, V <sub>GS</sub> =0V	-	-	1.3	V

#### Notes:

- 1.Pulse width limited by safe operating area.
- 2.Pulse width ≤300us , duty cycle ≤2%.

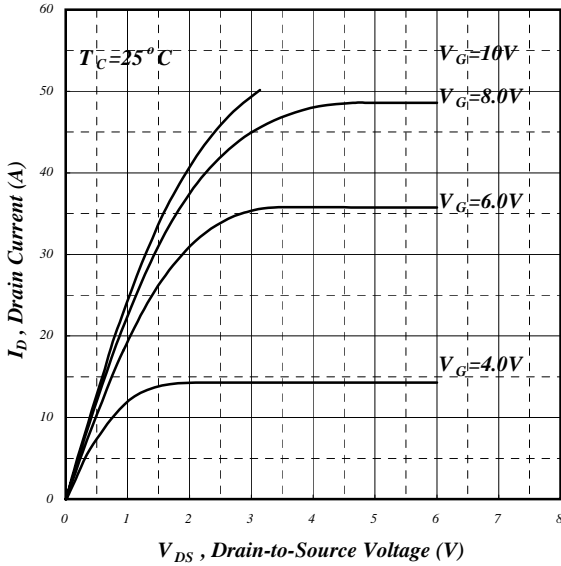


Fig 1. Typical Output Characteristics

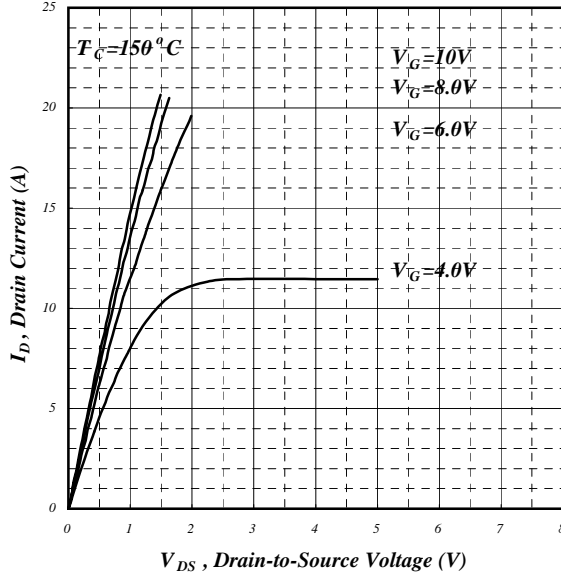


Fig 2. Typical Output Characteristics

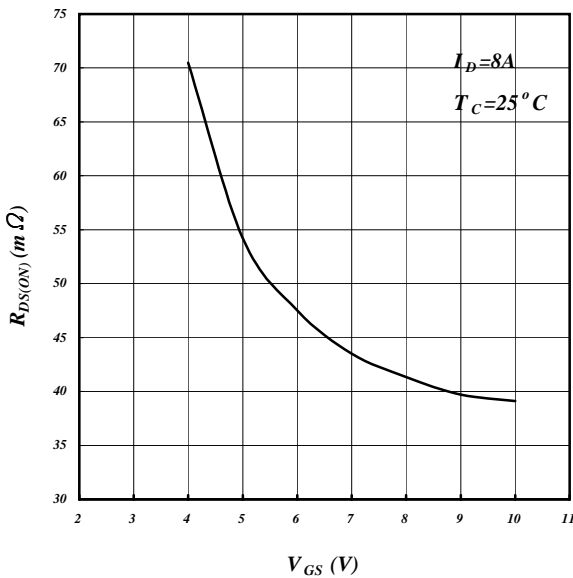


Fig 3. On-Resistance v.s. Gate Voltage

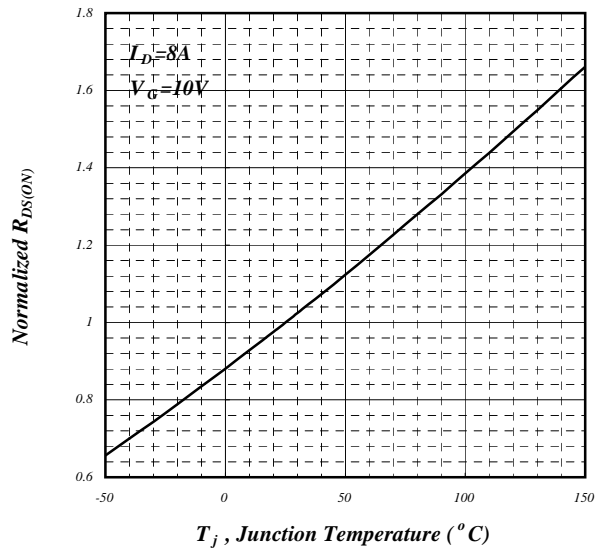
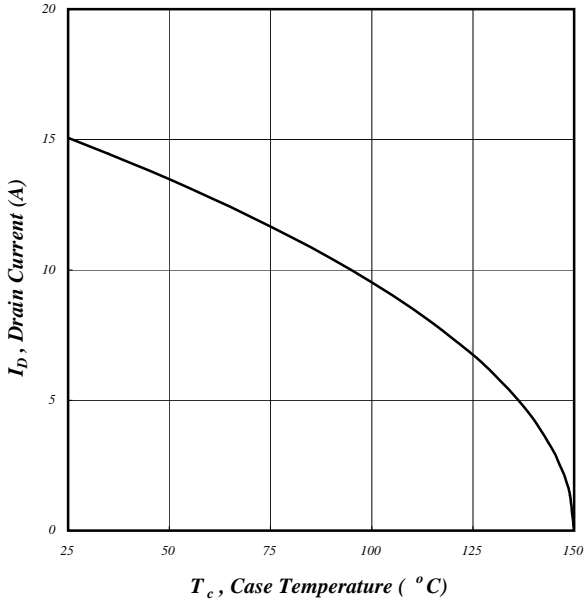


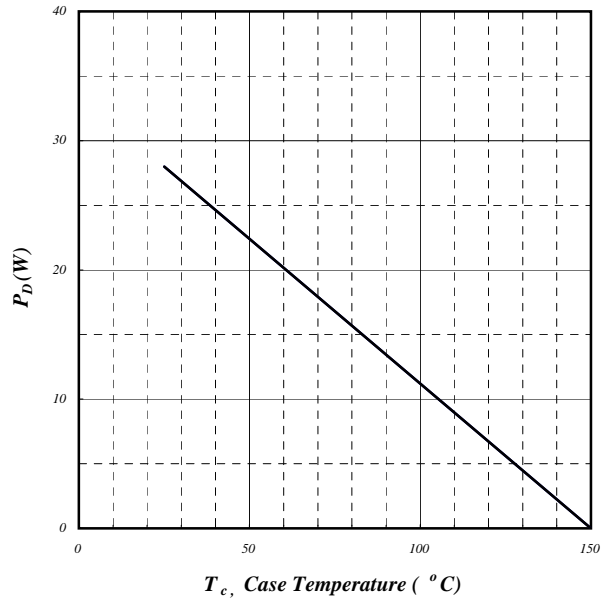
Fig 4. Normalized On-Resistance v.s. Junction Temperature



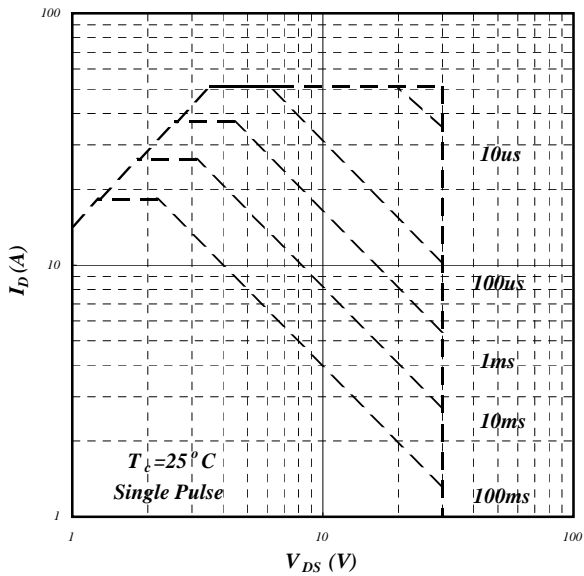
# AP15N03P



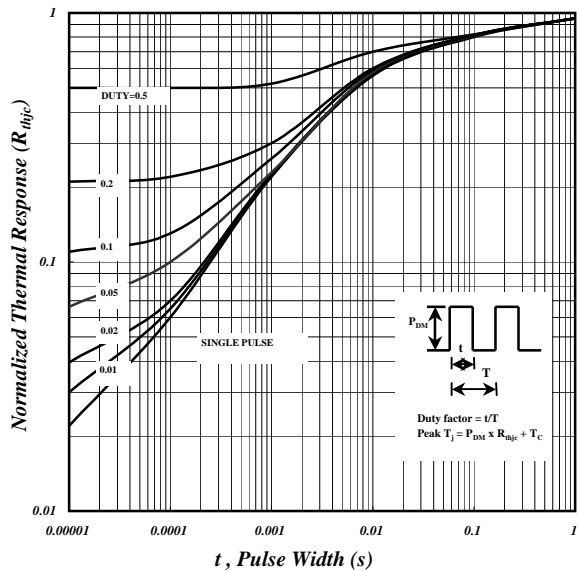
**Fig 5. Maximum Drain Current v.s. Case Temperature**



**Fig 6. Typical Power Dissipation**



**Fig 7. Maximum Safe Operating Area**



**Fig 8. Effective Transient Thermal Impedance**



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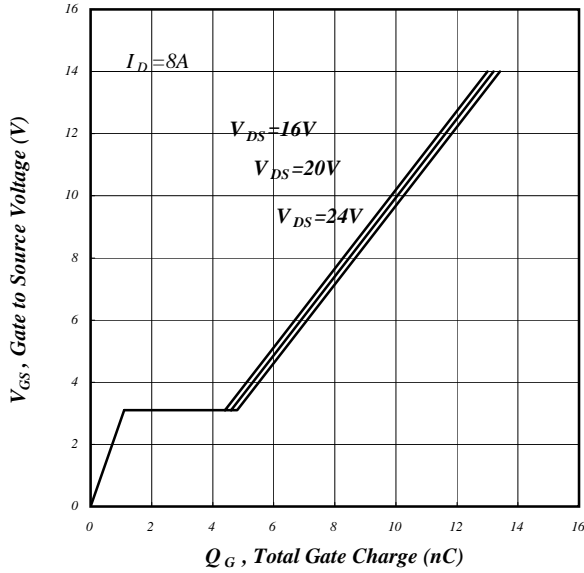


Fig 9. Gate Charge Characteristics

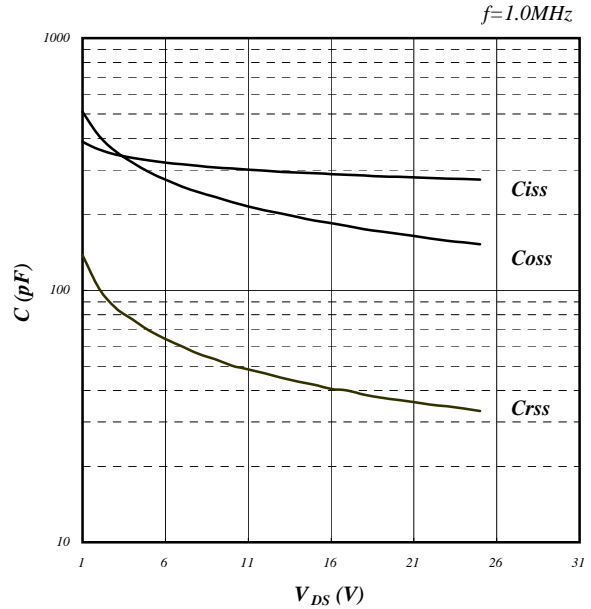


Fig 10. Typical Capacitance Characteristics

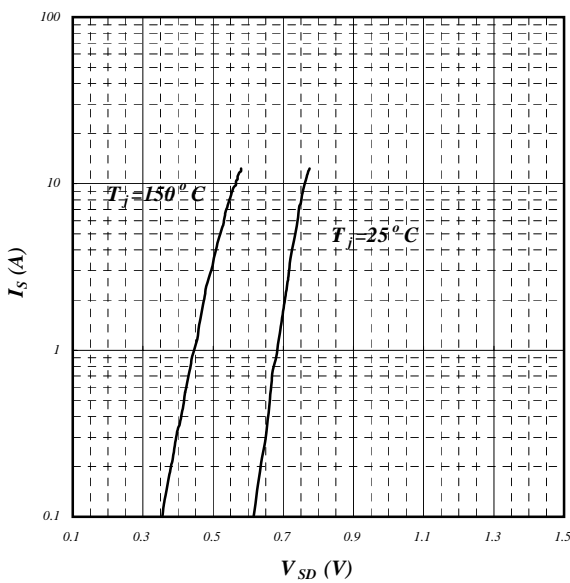


Fig 11. Forward Characteristic of Reverse Diode

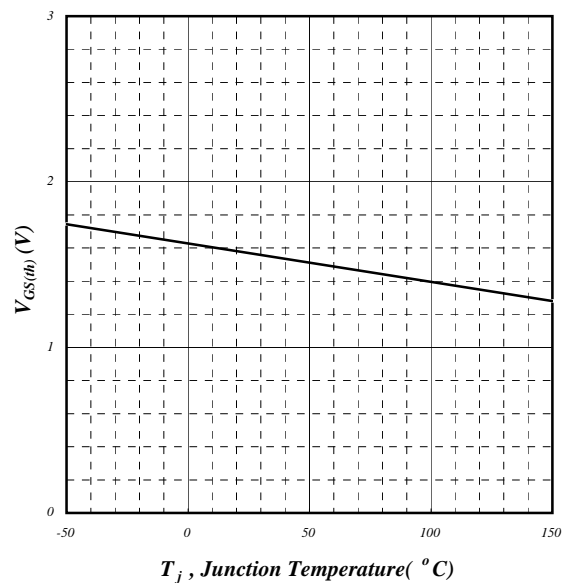
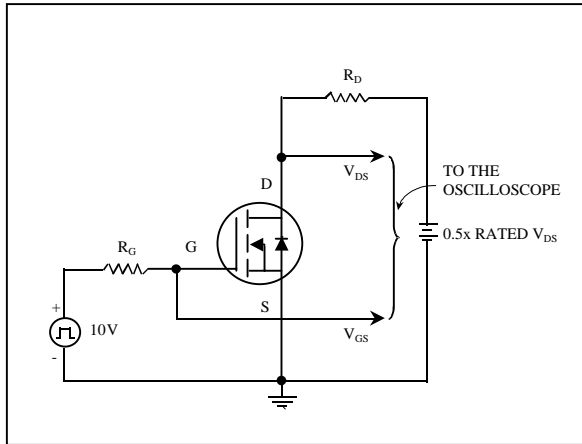


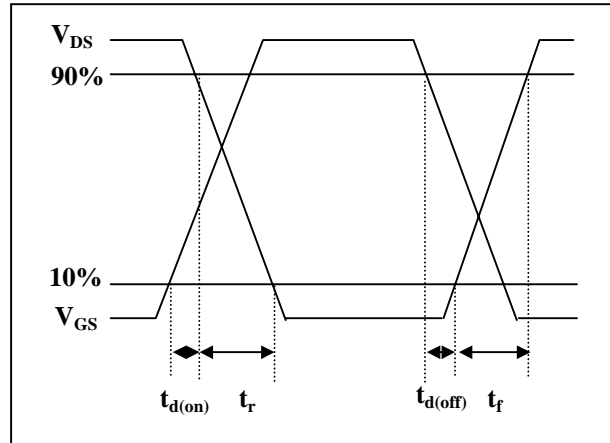
Fig 12. Gate Threshold Voltage v.s. Junction Temperature



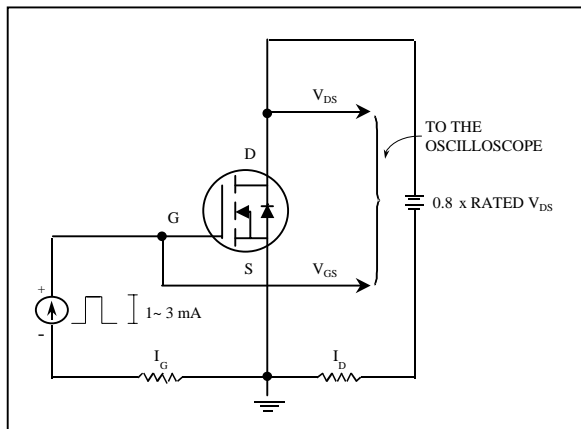
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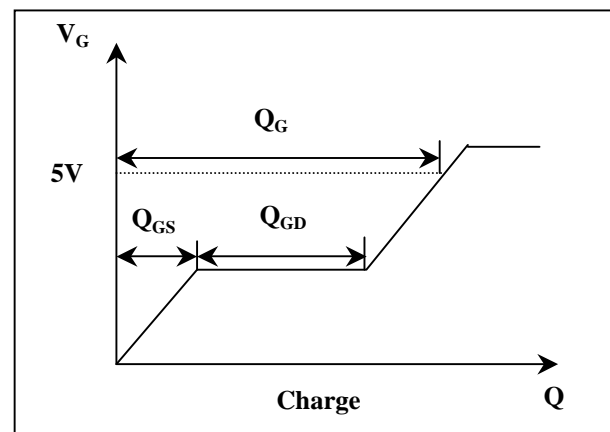
**Fig 13. Switching Time Circuit**



**Fig 14. Switching Time Waveform**



**Fig 15. Gate Charge Circuit**



**Fig 16. Gate Charge Waveform**